

Novel multi-channel skipper-CCD packages for the OSCURA[†] experiment

Ana Martina Botti* and Claudio Chavez

CPAD Workshop 2022

Nov 29 - Dec 2, 2022

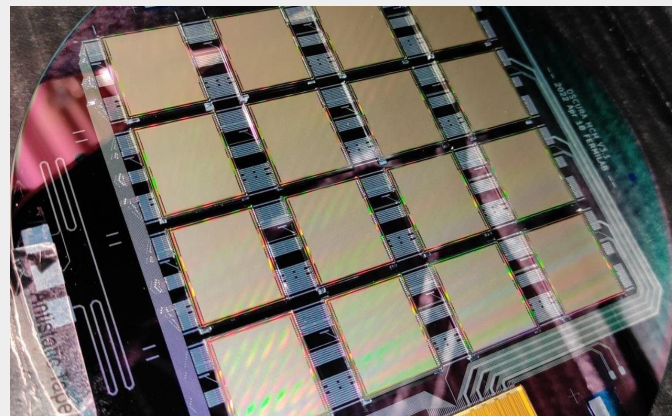
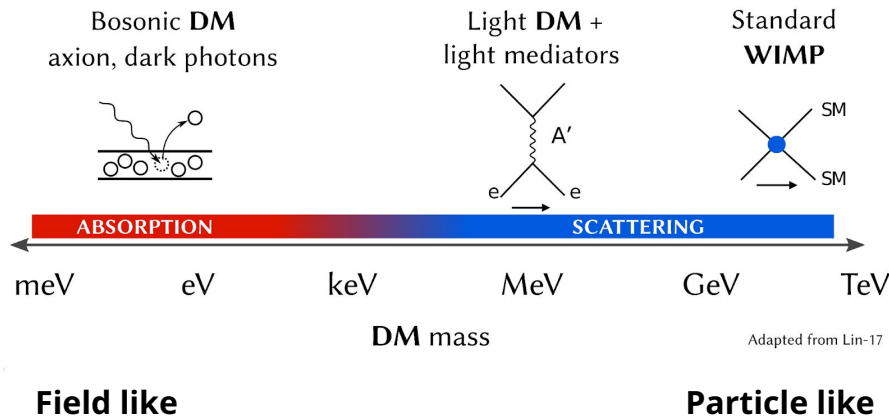


Image: OSCURA multi-chip module

* Fermi National Accelerator Laboratory · abotti@fnal.gov

† Observatory of Skipper CCDs Unveiling Recoiling Atoms · <https://astro.fnal.gov/science/dark-matter/oscura/>

Dark-matter direct detection



Weakly interacting massive particles:

- Favoured by Λ CDM
- experimentally accessible

Light dark matter:

- New theoretical models
- New enabling technologies (semiconductors, cryogenics, noble gasses, etc)

Search for sub-GeV dark matter in Silicon:

- e- recoils
- Nuclear recoils
- Absorption

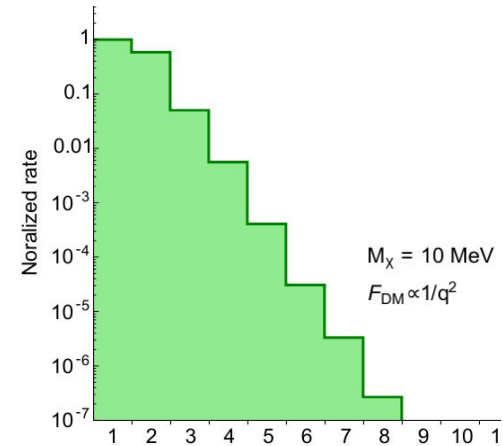
Light dark matter in Silicon

Light-**DM** mass range:

- 1-1000 MeV for **e⁻** recoil
- 1~1000 eV for **absorption**
- 0.5~1000 MeV **Nucleus** recoil (Migdal effect)

Sensitivity to **1,2,3 e⁻** signals needed: **Skippers-CCD** can do this!

Expected spectrum from benchmark models (e⁻ recoil)

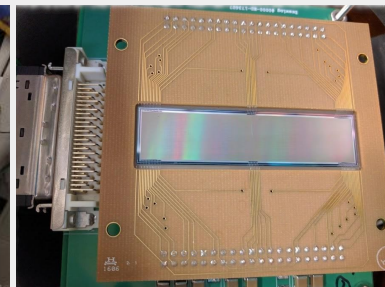


R. Essig et al, JHEP 05 (2016), 046

First Skipper-CCD prototypes

- New generation Charge Coupled Devices (**CCD**)
- Readout noise $\sim 0.1 e^-$
- Energy threshold ~ 1.1 eV (Si bandgap)
- Designed at **LBNL MSL**
- Parasitic run, optic coating and Si resistivity $\sim 10k\Omega$

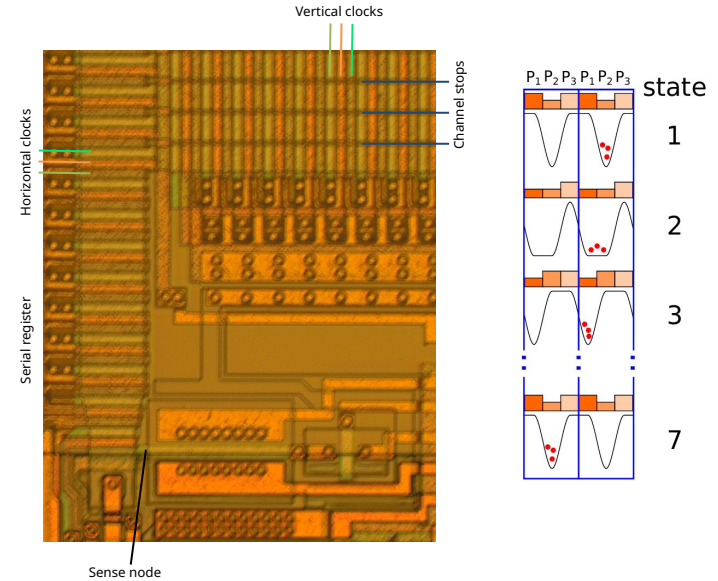
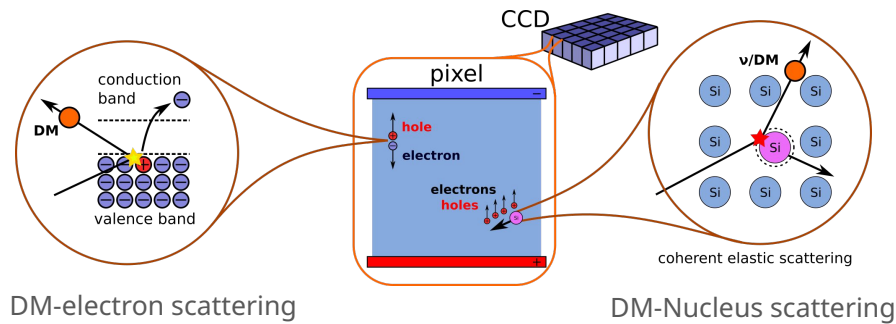
Tiffenberg, Javier, et al. Physical Review Letters 119.13 (2017): 131802.



Instrument:

- System integration done at **Fermilab**
- Custom cold electronics
- Firmware and image processing software
- Optimization of operation parameters

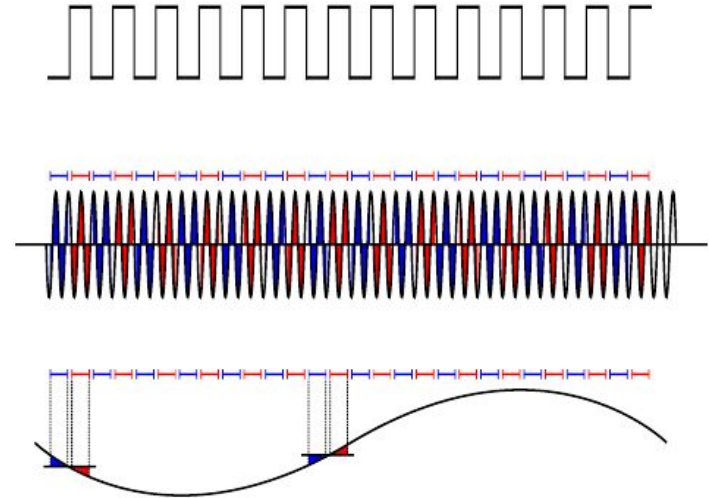
Charge-coupled devices (CCD)



Skipper CCD read-out

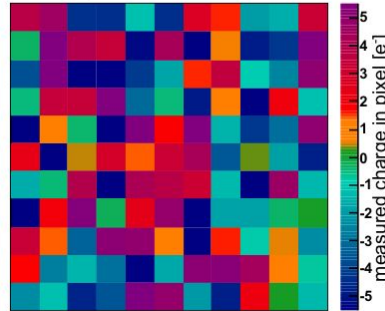
1. **pedestal** integration.
2. **signal** integration.
3. **charge** = **signal** - **pedestal**.
4. **Repeat** N times.
5. **Average** all samples.

Then, both high- and low-frequency noise is reduced

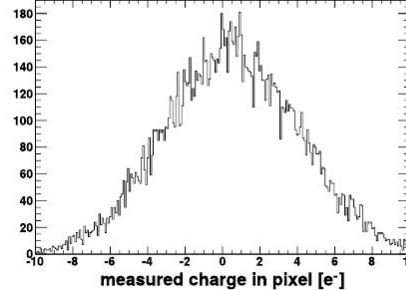


Skipper-CCD read-out noise

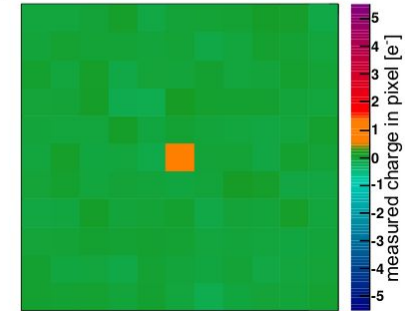
Standard CCD mode: charge in each pixel is measured once



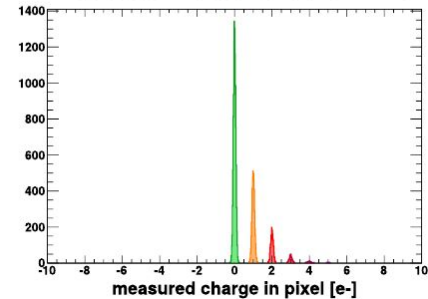
Readout-noise: 3.5 e RMS



New Skipper CCD: charge in each pixel is measured multiple times



Readout-noise: 0.06 e RMS



Perspectives: skipper CCDs and Dark Matter

SENSEI 100g (5 dru)

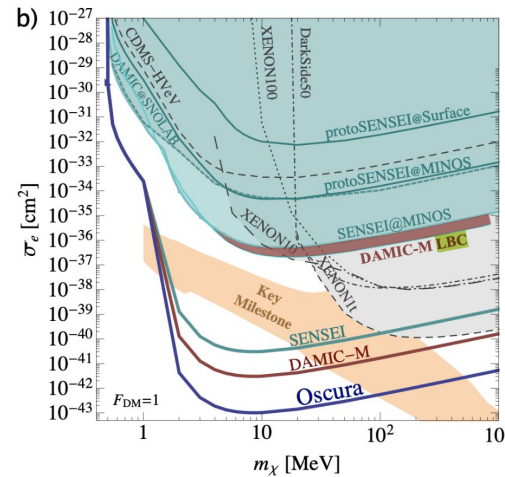
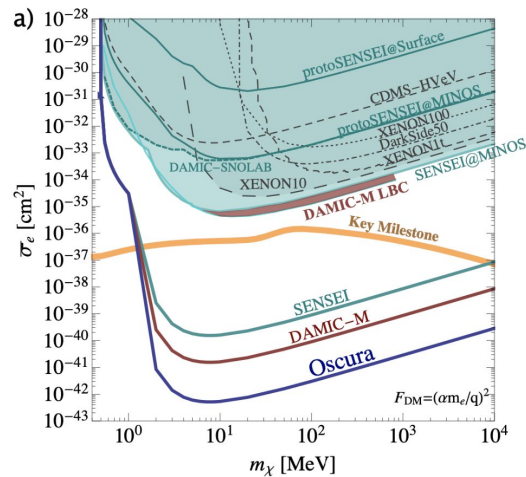
DAMIC-M 1kg (0.1 dru)

OSCURA 10kg (0.01 dru)

2021

2024

2027



**Many challenges to scale
the mass and reduce the
background in two order
of magnitude!**

*The Oscura Experiment
arXiv: 2202.10518*

Chavarria (arXiv:2210.05661)

OSCURA Collaborators



OSCURA package

10 kg skipper-CCDs:

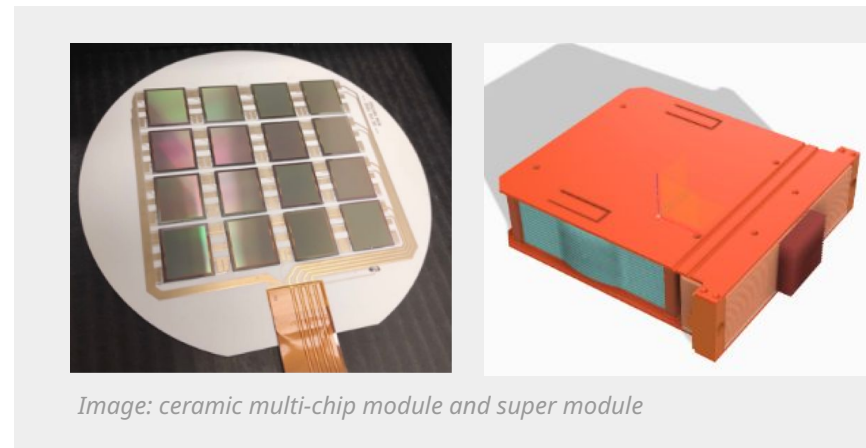
- 24000 channels/devices (28 GPix)
- 1500 multi-chip modules (MCM) with 16 CCDs each
- 94 super modules with 16 MCMs each

Read-out:

- High-density package (**This talk**)
- Multiplexer + SENSEI electronics (**see C. Chavez's talk**)
- ASICs (**see T. England talk**)

Background goal (0.01 dru):

- Silicon based pitch adapter (**This talk**)
- Aluminum shielding (**This talk**)
- Low-background materials



*C. Chavez et al. Sensors 22 (2022) 11, 4308
F. Chierchie et al. arXiv:2210.16418*

1st silicon prototypes

User proposal approved at Argonne National Laboratory

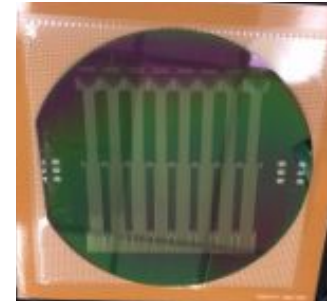


Based on SENSEI pitch adapters (at PNF/Chicago):

- 675 μm hires 6 in Si substrate
- 500 nm SiOx insulation
- 500 nm Al circuit
- 500 nm SiO₂ passivation



Image: SENSEI detector and pitch adapters produced at PNF



The SENSEI Collaboration. Phys. Rev. Lett. 125, 171802 (2020)

Silicon fabrication at ANL

Insulation layer:

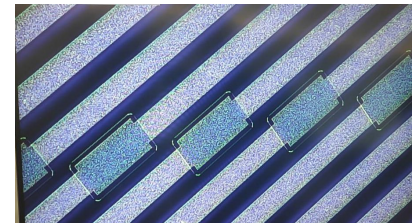
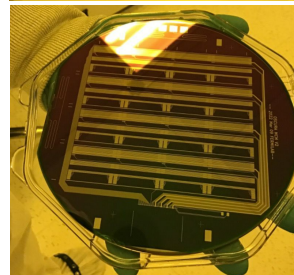
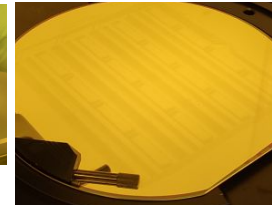
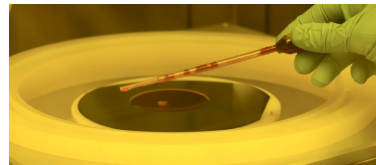
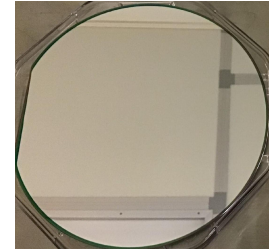
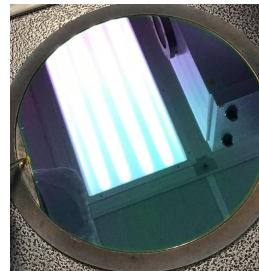
- AJA dielectric sputtering system at 400°C
- 390 nm SiO_2

Aluminum layer:

- AJA Metal sputtering system
- 480 μm Al on SiO_2
- 1 μm SPR-955 + Heidelberg MLA 150
- CD-26 developer + Al Type-A wet etcher

Passivation layer:

- AJA dielectric sputtering system at 275°C
- 390 nm SiO_2
- Oxford Plasmalab 100 dry etching
- e3511 ESI Plasma Asher (EOP)



Assembly and first tests

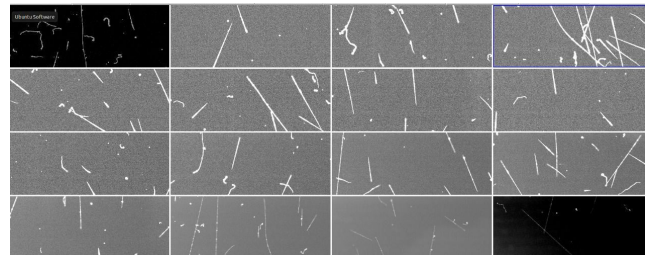
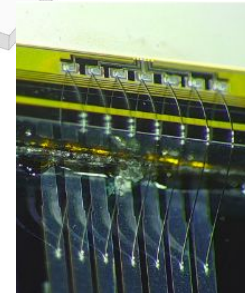
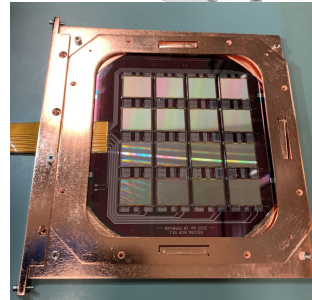
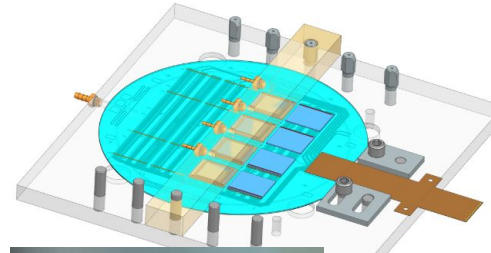
Tools developed for assembly and testing at FNAL

Assembly Process:

- Glue flex cable with laminate
- Glue CCDs with EPOxy
- Wire bonds

Testing:

- Electrical (shorts and impedance)
- Reverse bias
- Cold (with multiplexed read-out electronics)



Issues and outlook

Clock coupling in video out

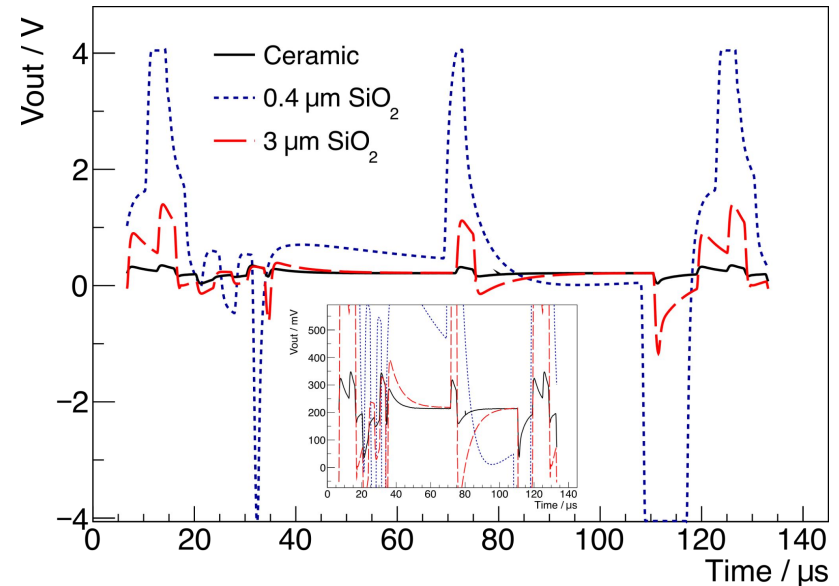
- Thicker insulation seems to help

Long recovery time

- Reduce resistivity
- Reduce capacitance

Next steps

- Thicker SiO₂
- Thicker metal (Al/Au)
- Intrinsic Si
- Change design rules



CCD aluminum shielding

Cooling down

- CCDs in LN2
- LN2 scintillates
- Cherenkov

Imagine throwing the CCD in a Cherenkov tank!

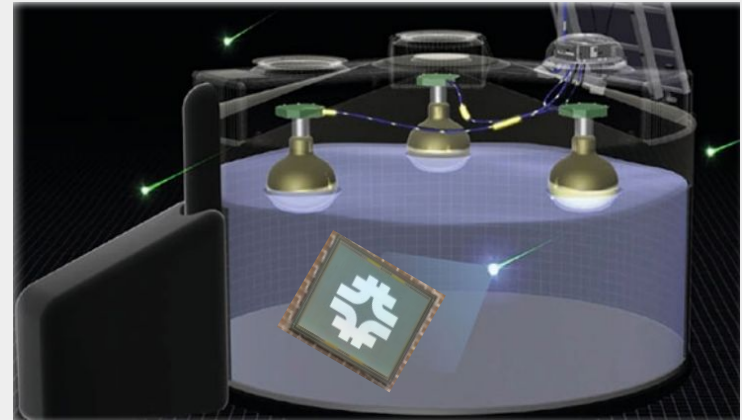


Image: CERN courier (The Pierre Auger Observatory)

CCD aluminum shielding

Lift-off process at ANL:

- 1um SPR-955 + Heidelberg MLA 150
- Temescal FC2000 E-Beam Evaporator
- 50 nm Al + 1165 remover

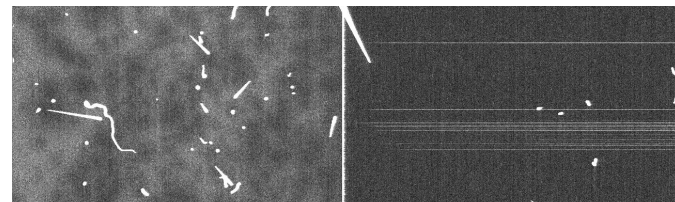
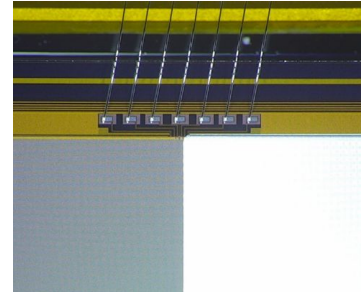
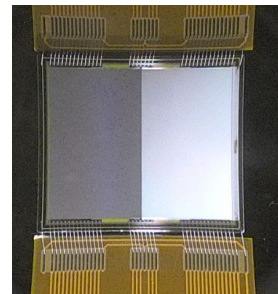
Testing:

- Expose to LED
- Expose to environmental radiation
- Some things to understand (but success in 1st try!)

Next steps:

- Extra cleaning
- Try different thickness
- Test with different wavelengths

Very important step for X-ray detection with skipper-CCDs!

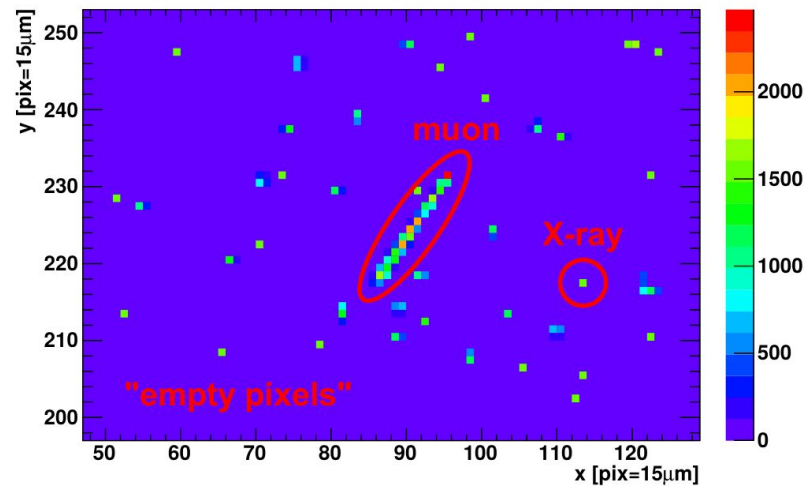
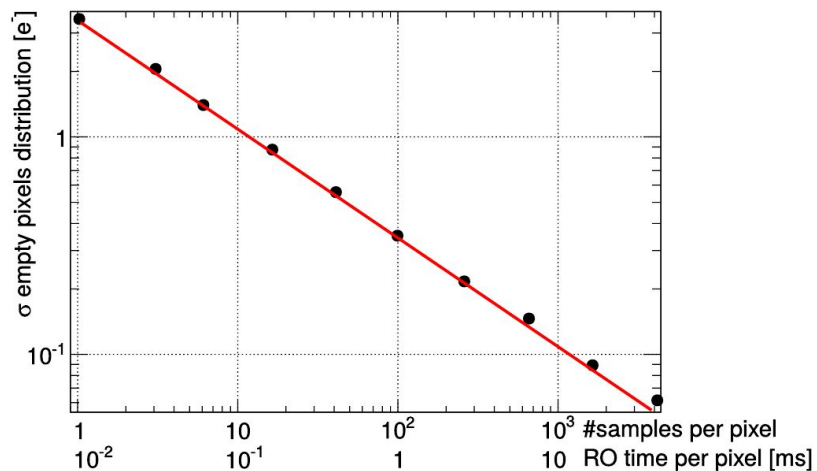


Summary

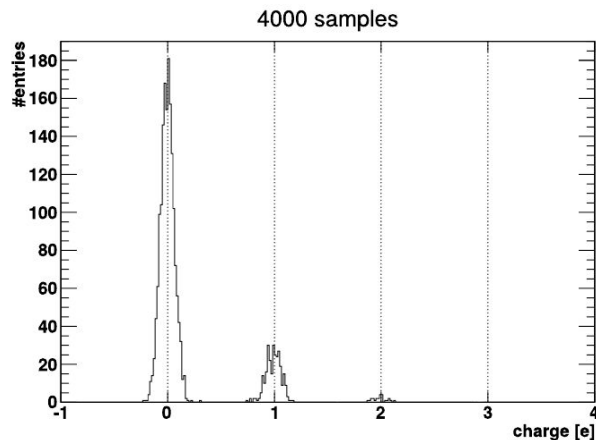
- **OSCURA** 10 kg skipper-CCD for light dark matter detection; major effort from most institutions working with **skipper-CCDs**
 - Background goal of **0.01 dru** is the main challenge
 - **24000** read-out channels/devices
 - First high-density package achieved (working ceramic version). First **Silicon** prototypes produced at **ANL**
 - Great improvement in first two versions
- Signal coupling and recovery time needs to be improved (**clear plans on how to**)
 - Further prototypes at **ANL** (and probably **PNF**)
 - Preliminary engagement with **production facility** to process **1500** wafers
 - First production of CCDs with **Aluminum shielding** at ANL. First tests were **successful** (more are coming)
 - Al shielding opens a door for **X-ray detection** with skipper CCDs (beyond OSCURA)

Backup slides

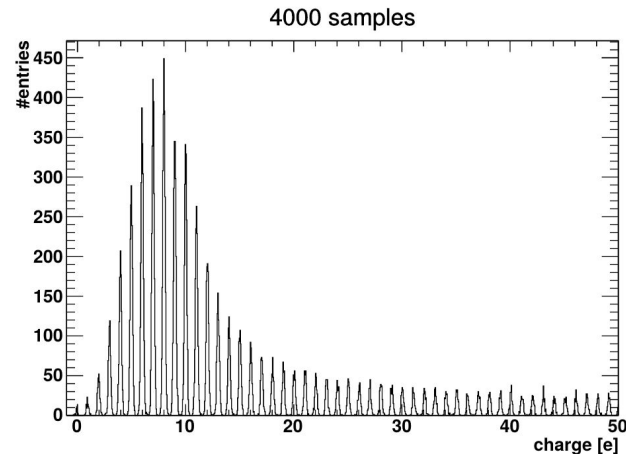
Skipper-CCD read-out noise



Skipper-CCD resolution



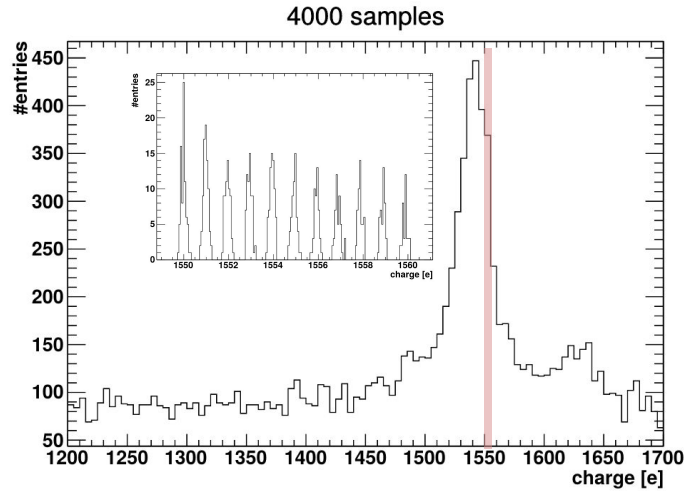
(Almost) Empty CCD



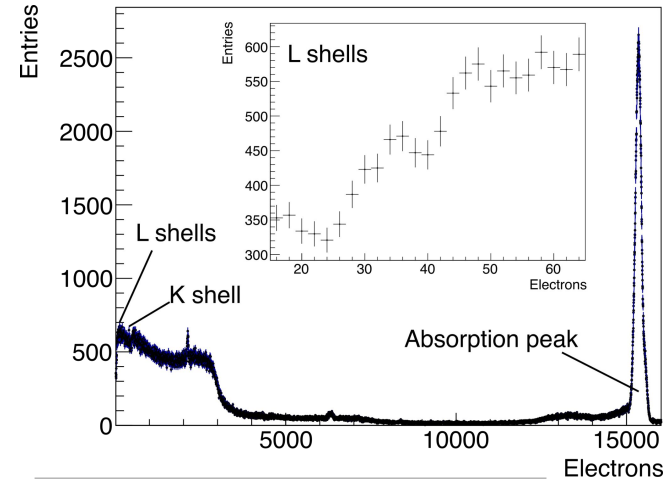
Front-illuminated CCD

Skipper-CCD for photo detection

D. Rodrigues et al., NIMA A 1010 165511



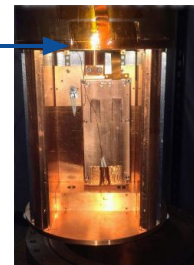
Charge per event for ^{55}Fe x-ray source



*Compton scattering spectrum in
Silicon with ^{241}Am γ -ray source*

Setup @ MINOS

- 230 m.w.e.
- Previous vessel + extra shielding
- $T \sim 135$ K + vacuum
- LTA board

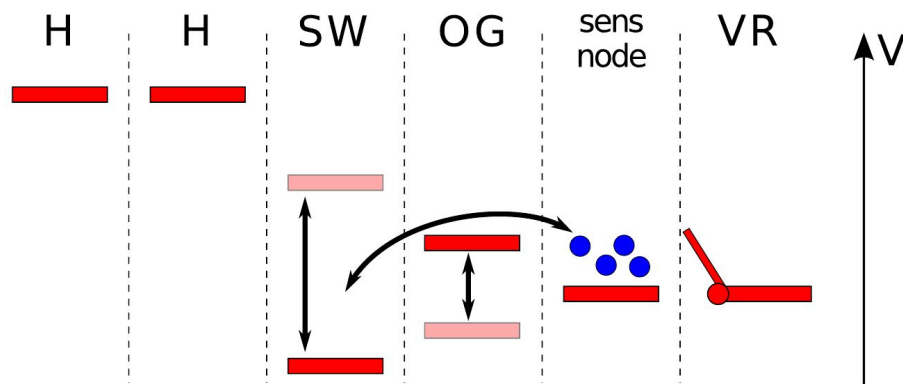


Skipper CCD read-out

Multiple sampling of same pixel without corrupting the **charge** packet.

Pixel value = **average** of all samples

Suggested in **1990** by Janesick et al.
(doi:10.1117/12.19452)



Background sources: detector

Exposure dependent

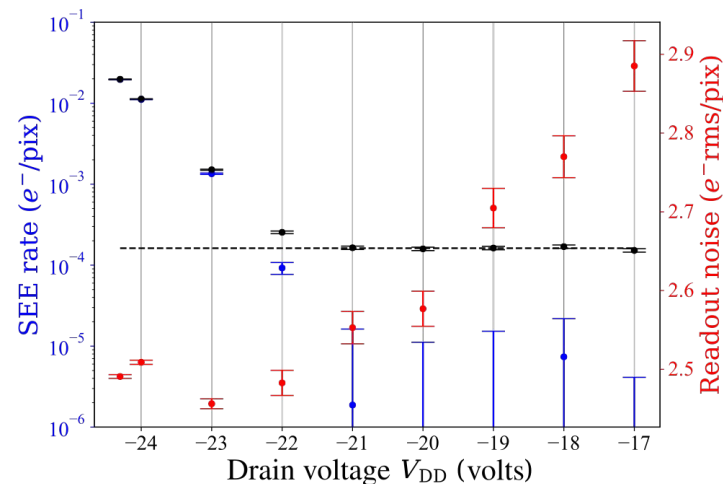
- Dark current (10^{-5} e⁻/pix/day at 135 K)
- Amplifier light (10^{-1} to 10^{-5} e⁻/pix/day)

Exposure independent

- Spurious charge (10^{-2} to 10^{-5} e⁻/pix/image)

Single electron rate reduced by optimizing operation parameters

- Read-out mode: continuous vs expose
- Voltage configuration
- Amplifier off while exposure



The SENSEI Collaboration. Phys. Rev. Applied 17, 014022 (2022)

Background sources: environment

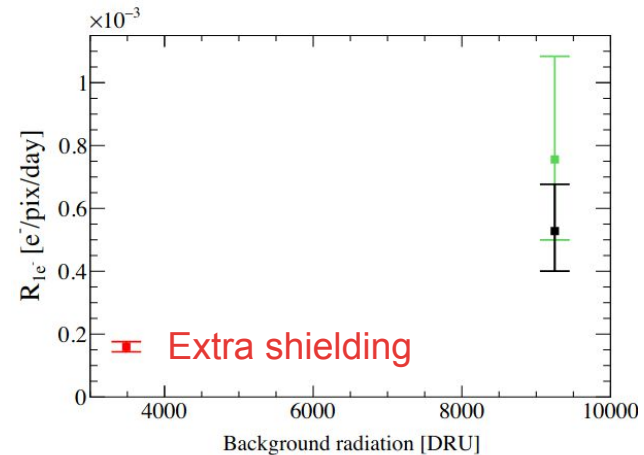
High-energy:

- Air shower muons
- Nuclear decays
- x/γ-rays

Low-energy:

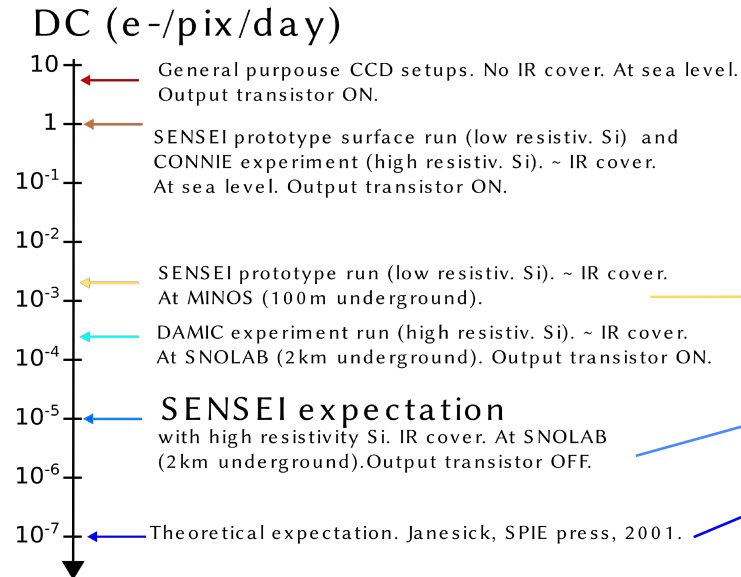
- IR photons
- Halo and transfer inefficiency
- Compton scattering
- Charge collection inefficiency

Environmental background is reduced with shielding, and removed from data with quality cuts



The SENSEI Collaboration - Phys. Rev. Lett. 125, 171802 (2020)

Background goal



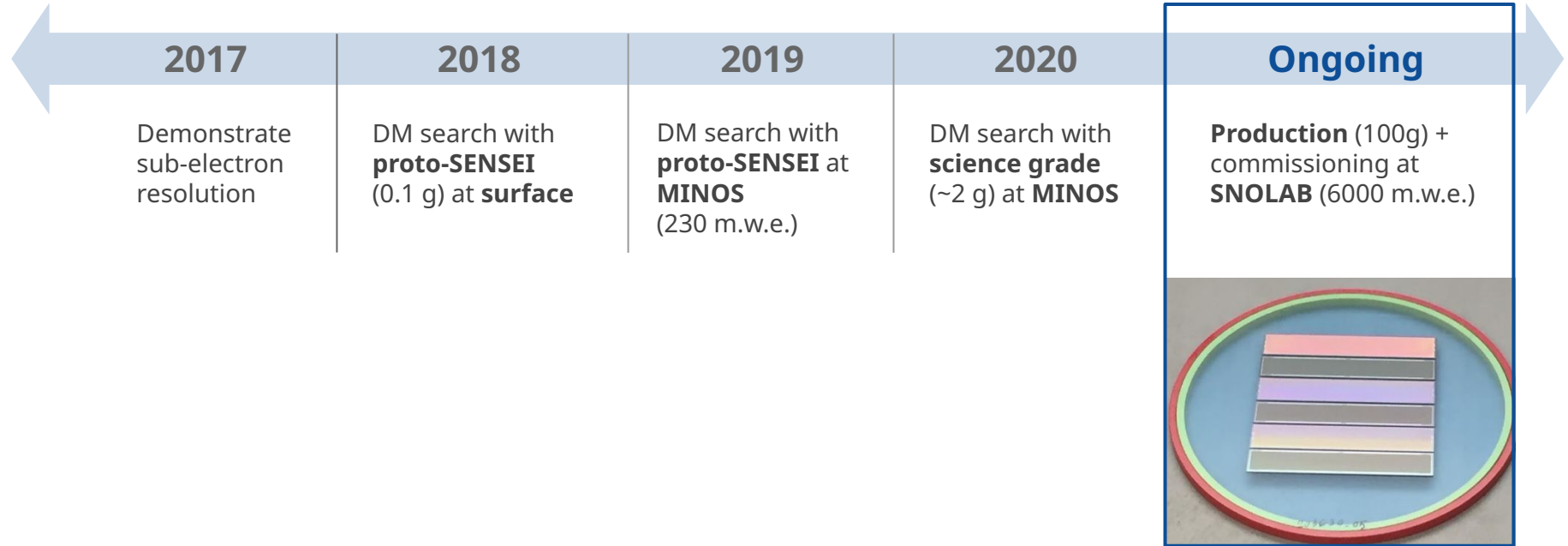
Dark Current [e ⁻ pix ⁻¹ day ⁻¹]	≥ 1e ⁻ [pix]	≥ 2e ⁻ [pix]	≥ 3e ⁻ [pix]
10 ⁻³	1 × 10 ⁸	3 × 10 ³	7 × 10 ⁻²
10 ⁻⁵	1 × 10 ⁶	3 × 10 ⁻¹	7 × 10 ⁻⁸
10 ⁻⁷	1 × 10 ⁴	3 × 10 ⁻⁵	7 × 10 ⁻¹⁴

Background estimations for 1 year and 100 g.

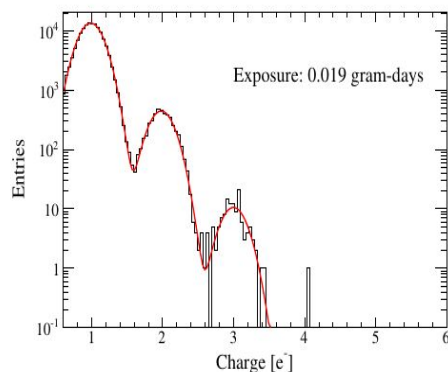
Blue: discovery channel (background free)
Red: modulation or limits

Latest SENSEI published result: **1.6x10⁻⁴ e-/pix/day**

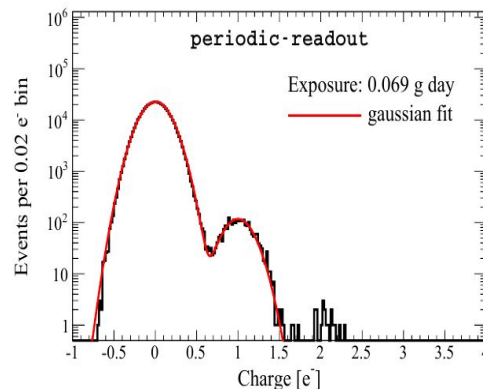
The Experiment



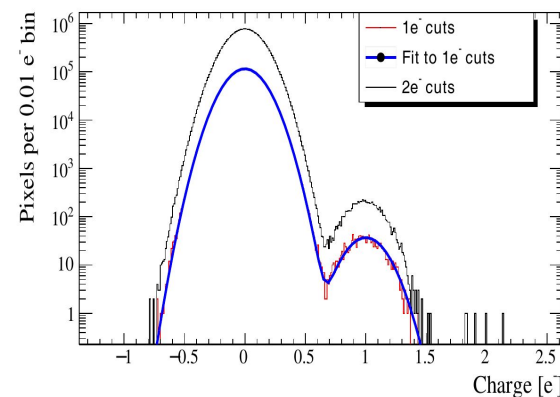
Summary: from prototype to science grade



Active mass ~ **0.1 g**
0.019 gram-day exposure
 0.14 e- RO noise
 (800 samples)
 SEE ~ **1.14 e-/pixel/day**



Active mass ~ **0.1 g**
0.069 gram-day exposure
 0.14 e- RO noise
 (800 samples)
 SEE ~ **0.005 e-/pix/day**



Active mass ~ **2 g**
19.926 gram-day exposure
 0.14 e- RO noise
 (300 samples)
 SEE ~ **1.6×10^{-4} e-/pix/day**

SENSEI @ SNOLAB



- Science-grade skipper-CCDs achieved
- Packaging and electronics also achieved
- Phase 1 system @ SNOLAB
- Vessel deployed at SNOLAB (during the pandemic!!!)
- First 10 CCDs deployed

Towards a **100 g** skipper-CCD detector:

- Produce ~ **50** devices
- **Packaging** at Fermilab
- **Testing**
- Deliver and deploy at **SNOLAB**

- **10000** dru (MINOS standard shield): proto-SENSEI
- **3000** dru (MINOS extra shield): first science grade skipper
- **5 (ultimate goal)** dru (SNOLAB): SENSEI 100 g

